

Office

11-13-2002



LY

CS00-038

To the Honorable Commissioner of Patents

102281182

original documents or copy thereof.

1. Name of conveying party(ies):

**Chartered Semiconductor Manufacturing Inc.**

2. Name and address of receiving party(ies):

Name: **Chartered Semiconductor Manufacturing Ltd.**

Internal Address:

Street Address:

**60 Woodlands Industrial Park D  
Street 2  
City: Singapore Zip: 738406  
Country: Singapore**

Additional name(s) or conveying party(ies) attached?  Yes  No

11-7-02

3. Nature of conveyance

Assignment  Merger

Security Agreement  Change of Name

other \_\_\_\_\_

Execution Date: **6/19/02**

Additional name(s) & address(es) attached? Yes  No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No(s)

09/670,329

B. Patent No.(s)

9/27/00

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **GEORGE O. SAILE**

Internal Address: \_\_\_\_\_

Street Address: **28 DAVIS AVENUE**

City: **POUGHKEEPSIE** State: **NY** ZIP: **12603**

6. Total no. of applications and patents involved: **1**

7. Total fee (37 CFR 3.41): **\$ 40.00**

Enclosed

Authorized to be charged to deposit acct.

8. Deposit account number: **19-0033**

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature .

To the best of my knowledge and belief the foregoing information is true and correct and any attached copy is a true copy of the original document

**STEPHEN B. ACKERMAN**

Name of Person Signing

Signature

**11/4/02**

Date

11/12/2002 T0IAZ1 00000059 190033 09670329

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Total number of pages comprising cover sheet: **1**

CS00-038

For  U.S. and/or  Foreign Rights

For  Application or  U.S. Patent

By  Inventor(s) or  Present Owner

**ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

**ASSIGNOR:**

Chartered Semiconductor Manufacturing Inc.

Type or print name of ASSIGNOR

1450 McCandless Drive

Address

Milpitas, CA 95035

USA

Nationality

**ASSIGNEE:**

**Chartered Semiconductor Manufacturing Ltd.**

**60 Woodlands Industrial Park D**

**Street 2**

**Singapore 738406**

**Singapore**

Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

*(complete one of the following)*

the entire right, title and interest

an undivided \_\_\_\_\_ percent (\_\_\_%) interest for the United States and its territorial possessions

*(check the following box/f foreign rights are also to be assigned)*

and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

**A Method Of Forming Dual Thickness Gate Dielectric Structures Via Use Of Silicon Nitride Layers**

and which is found in

- (a)  U.S. patent application executed on even date herewith
- (b)  U.S. patent application executed on \_\_\_\_\_
- (c)  U.S. application serial no. 09/670,329 filed on 9/27/00
- (d)  U.S. patent no. \_\_\_\_\_ issued \_\_\_\_\_  
*(also check (e) if foreign application(s) is also being assigned)*
- (e)  and any legal equivalent thereof in a foreign country, including the right to clam priority

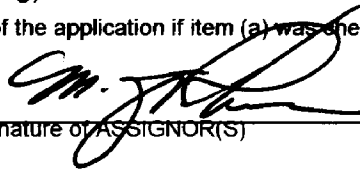
and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I / We have signed this  
JUNE 19, 2002 (Date of signing)

**WARNING** Date of signing must be the same as the date of execution of the application if item (a) was checked above.

  
 \_\_\_\_\_  
 Signature of ASSIGNOR(S)  
 \_\_\_\_\_  
 \_\_\_\_\_  
 \_\_\_\_\_

If ASSIGNOR is a legal entity complete the following information

Mike Rekuc  
 \_\_\_\_\_  
 Type or print the name of the above person authorized to sign on  
 behalf of ASSIGNOR  
  
President  
 \_\_\_\_\_  
 Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

\_\_\_ Notarization of Legalization Page Added.